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## **Amendments to Claims:**

Please amend the claims as in the following listing:

## What is claimed is:

1	1. (currently amended) A method of manufacture of magnetic heads which include CoFe
2	elements using CMP, comprising:
3	A) providing a slurry of Al <sub>2</sub> O <sub>3</sub> ; providing magnetic heads which include CoFe
4	elements;
5	B) adjusting the concentration of H <sub>2</sub> O <sub>2</sub> in said slurry to within a range of 6-12%
6	by volume; and providing a slurry including Al <sub>2</sub> O <sub>3</sub> and H <sub>2</sub> O <sub>2</sub> ;
7	C) balancing mechanical polishing action. adjusting the concentration of H <sub>2</sub> O <sub>2</sub> in
8	said slurry to within a range of 6-12% by volume; and
9	D) balancing mechanical polishing action.
10	
1	2. (original) The method of manufacture of magnetic heads of claim 2, wherein C)
2	includes:
3	adjusting the table speed of a mechanical polisher to within a range of 55-90 rpm.
•	2 (-visited) The weeth of a foregon feature of magnetic heads of alaim 2 whomis ()
l	3. (original) The method of manufacture of magnetic heads of claim 2, wherein C)
2	includes: adjusting polishing pressure to within a range of 5-7 psi.
3	adjusting polishing pressure to within a range of 3-7 psi.
i	4. (original) The method of manufacture of claim 1, wherein:
2	said slurry of A) includes BTA (1H-benzotriazole).
4	suid blurry of 15) morados s 111 (111 donada lassos).
1	5. (original) The method of manufacture of claim 1, wherein:
2	said slurry of A) includes Isothiazolone.
1	6. (original) The method of manufacture of claim 1, wherein:
2	the particle size of Al <sub>2</sub> O <sub>3</sub> is in the range of 50-500nm.
1	7. (original) The method of manufacture of claim 1, wherein:
2	the pH of the slurry is in the range of 4-6.
_	
1	8. (withdrawn) A magnetic head which include CoFe elements produced by the process
2	comprising:
3	A) providing a slurry of Al <sub>2</sub> O <sub>3</sub> ;
4	B) adjusting the concentration of H <sub>2</sub> O <sub>2</sub> in said slurry to within a range of 6-12%
5	by volume; and
6	C) balancing mechanical polishing action.
1	9. (withdrawn) The magnetic head of claim 8, wherein C) of the process further
2	comprises:
4	comprised.

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adjusting the table speed of a mechanical polisher to within a range of 55-90 3 4 rpm. 10. (withdrawn) The magnetic head of claim 8, wherein C) of the process further Ì 2 comprises: adjusting polishing pressure to within a range of 5-7 psi. 3 11. (withdrawn) The method of manufacture of claim 8, wherein: 1 said slurry of A) includes BTA (1H-benzotriazole). 2 12. (withdrawn) The method of manufacture of claim 8, wherein: 1 said slurry of A) includes Isothiazolone. 2 13. (withdrawn) The method of manufacture of claim 8, wherein: 1 the particle size of Al<sub>2</sub>O<sub>3</sub> is in the range of 50-500nm. 2 14. (withdrawn) The method of manufacture of claim 8, wherein: 1 the pH of the slurry is in the range of 4-6. 2 15. (withdrawn) A slurry for CMP of magnetic head elements including CoFe material, comprising: 1 Al<sub>2</sub>O<sub>3</sub> as an abrasive; and H<sub>2</sub>O<sub>2</sub> in concentration within a range of 6-12% by volume. 2 16. (withdrawn) The slurry for CMP of magnetic head elements of claim 15, further 1 2 comprising: 3 BTA (1H-benzotriazole). 17. (withdrawn) The slurry for CMP of magnetic head elements of claim 15, further 1 2 comprising: 3 Isothiazolone. 18. (withdrawn) The slurry for CMP of magnetic head elements of claim 15, wherein: 1 the particle size of  $Al_2O_3$  is in the range of 50-500nm. 2 1 19. (withdrawn) The slurry for CMP of magnetic head elements of claim 15, wherein: the pH of the slurry is in the range of 4-6. 2 20. (new) A method of manufacture of magnetic heads which include CoFe elements 1 2 using CMP, comprising: 3 A) providing magnetic heads which include both CoFe elements and Al<sub>2</sub>O<sub>3</sub> 4 elements: B) providing a slurry including Al<sub>2</sub>O<sub>3</sub> and H<sub>2</sub>O<sub>2</sub>; 5 C) adjusting the concentration of H<sub>2</sub>O<sub>2</sub> in said slurry to within a range of 8-12% 6 7 by volume; and

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8 D) balancing mechanical polishing action.

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